**Product data sheet** 

## 1. General description

Dual common cathode power Schottky diode designed for high frequency switched mode power supplies in a TO-263(D2PAK) plastic package.

## 2. Features and benefits

- Trench structure
- · High junction temperature up to 150°C
- High efficiency
- Low forward voltage drop, negligible switching losses

## 3. Applications

- DC to DC converters
- Freewheeling diode
- · OR-ing diode

## 4. Quick reference data

#### Table 1. Quick reference data

	k reference data		1	1			_
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage			-	-	100	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; T <sub>mb</sub> ≤ 133 °C; square-wave pulse; per diode; Fig. 1; Fig. 2; Fig. 3		-	-	20	Α
I <sub>O(AV)</sub>	average output current	$\delta$ = 0.5 ; T <sub>mb</sub> ≤ 130 °C; square-wave pulse; both diodes conducting		-	-	40	Α
Static chara	cteristics						
$V_{F}$	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u> ; per diode		-	0.53	0.59	V
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 125 °C; <u>Fig. 6</u> ; per diode		-	0.49	0.56	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u> ; per diode		-	0.64	0.71	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 125 °C; <u>Fig. 6</u> ; per diode		-	0.61	0.68	V
I <sub>R</sub>	reverse current	$V_R = 100 \text{ V; } T_j = 25 \text{ °C; } Fig. 7; Fig. 8; $ per diode		-	-	50	μΑ
		V <sub>R</sub> = 100 V; T <sub>j</sub> = 125 °C; <u>Fig. 7</u> ; <u>Fig. 8</u> ; per diode		-	-	40	mA

# **5. Pinning information**

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	mb	A1   D  + K1   A2
2	K	cathode		A1 [N ] A2
3	A2	anode 2	0	K sym125
mb	К	mounting base; connected to cathode		
			D2PAK (TO-263E)	

# 6. Ordering information

## **Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
WNS40H100CB	D2PAK	plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped)	TO-263E

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	100	V
$V_{RWM}$	limiting crest working reverse voltage		-	100	V
$V_R$	limiting reverse voltage	DC	-	100	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; T <sub>mb</sub> ≤ 133 °C; square-wave pulse; per diode; Fig. 1; Fig. 2; Fig. 3	-	20	А
I <sub>O(AV)</sub>	average output current	$\delta$ = 0.5 ; T <sub>mb</sub> ≤ 130 °C; square-wave pulse; both diodes conducting	-	40	А
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 10 ms; T <sub>j(init)</sub> = 25 °C; sine-wave pulse; per diode; <u>Fig. 4</u>	-	380	А
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	-	418	Α
T <sub>stg</sub>	storage temperature		-40	150	°C
T <sub>j</sub>	junction temperature		-	150	°C

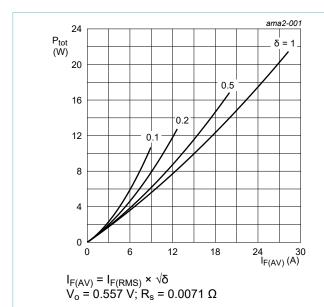


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode

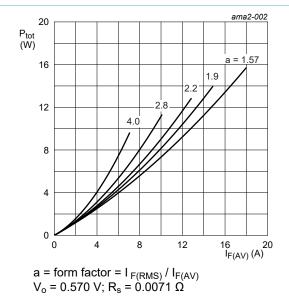


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values; per diode

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### **Dual power Schottky diode**

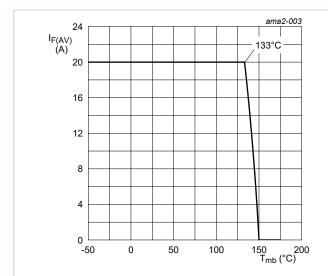


Fig. 3. Average forward current as a function of mounting base temperature; maximum values; per diode

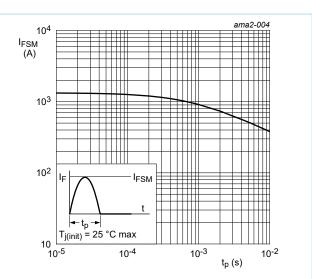


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values; per diode

## 8. Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance	per diode; Fig. 5	-	-	1	K/W
	from junction to mounting base	both diodes conducting	-	-	0.6	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	60	-	K/W

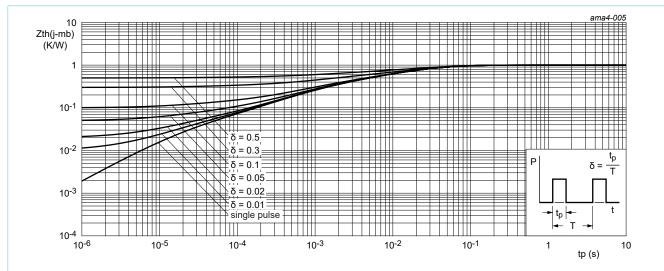


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum values; per diode

### 9. Characteristics

**Table 6. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Static charact	Static characteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u> ; per diode		-	0.53	0.59	V	
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 125 °C; <u>Fig. 6</u> ; per diode		-	0.49	0.56	V	
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u> ; per diode		-	0.64	0.71	V	
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 125 °C; <u>Fig. 6</u> ; per diode			0.61	0.68	V	
I <sub>R</sub>	reverse current	V <sub>R</sub> = 100 V; T <sub>j</sub> = 25 °C; <u>Fig. 7</u> ; <u>Fig. 8</u> ; per diode		-	-	50	μΑ	
		V <sub>R</sub> = 100 V; T <sub>j</sub> = 125 °C; <u>Fig. 7</u> ; <u>Fig. 8</u> ; per diode		-	-	40	mA	

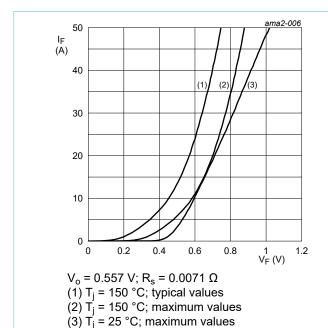
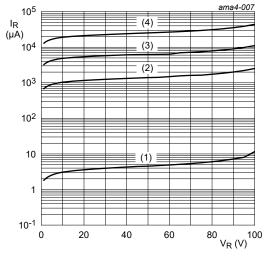
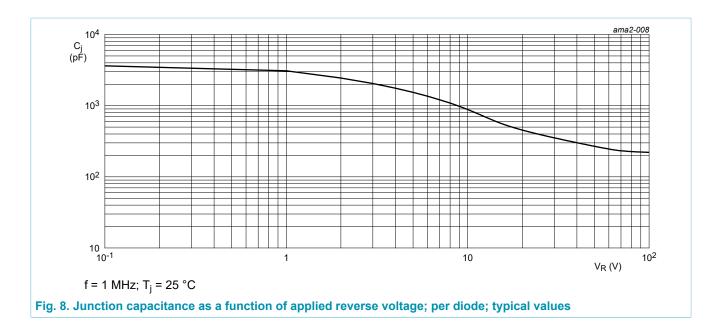


Fig. 6. Forward current as a function of forward voltage; per diode

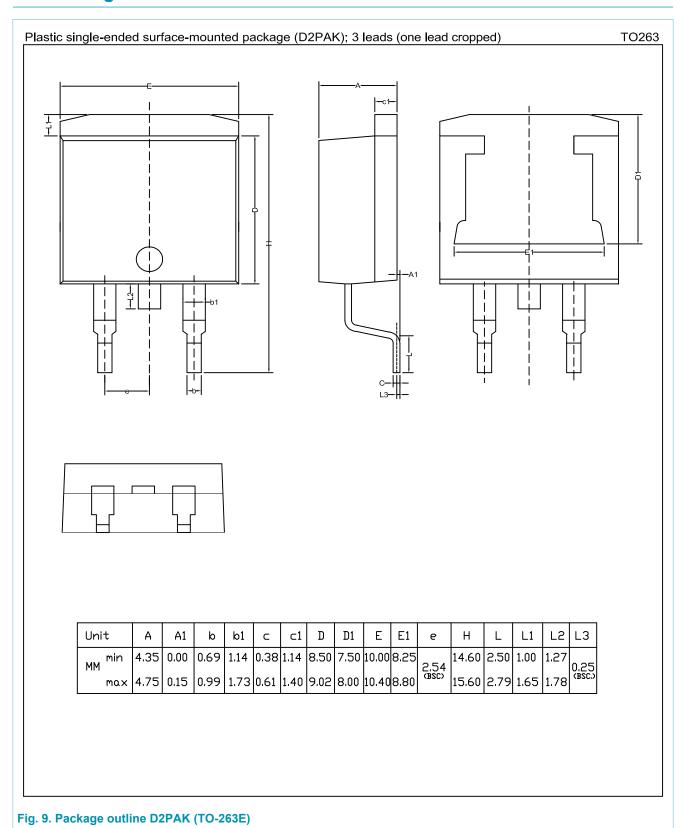


- (1) T<sub>j</sub> = 25 °C; typical values
- (2)  $T_j = 100 \,^{\circ}\text{C}$ ; typical values (3)  $T_j = 125 \,^{\circ}\text{C}$ ; typical values
- (4) T<sub>i</sub> = 150 °C; typical values

Fig. 7. Reverse leakage current as a function of reverse voltage; per diode; typical values



## 10. Package outline



WNS40H100CB

# 11. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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